

# 带有升压直流/直流转换器、电平转换器和 ESD 钳位的 TPD5S115 HDMI 配套芯片

## 1 特性

- 符合 HDMI 合规性测试，无需任何外部组件
- 支持 HDMI 2.0、HDMI 1.4 和 HDMI 1.3 标准
- 与 HDMI 连接器引脚映射相匹配
- 内部 DC-DC 转换器以从一个低至 2.3V 的电池电压生成 5V 电压
- CEC、SDA 和 SCL 路径内的自动方向感应、电平转换和缓冲
- IEC 61000-4-2 (4 级) 系统级 ESD 兼容
- 反向电流阻断和短路保护以防止出现故障状况
- 工业温度范围：-40°C 至 85°C

## 2 应用

- 机顶盒
- 电视
- 智能手机
- 数码摄像机
- 便携式游戏机
- 数码相机

## 3 说明

TPD5S115 器件是一款集成式 HDMI 配套芯片解决方案。该器件提供稳定的 5V 输出电压 (5VOUT)，用于为 HDMI 电源线路供电。稳定的 5V 输出电压可为 HDMI 接收器提供高达 55mA 的电流，同时具备电流限制功能。TPD5S115 采用两个控制信号：EN 和 LS\_OE。5VOUT 和热插拔检测 (HPD) 电路的控制独立于 LS\_OE 控制信号，并由 EN 引脚控制。EN 引脚可在打开整个 HDMI 链路之前激活检测系统 (5VOUT+HPD)。只有当 EN 也被激活时，LS\_OE 才激活内部 LDO，CEC，SCL 和 SDA 缓冲器。这个双极启用方案能够确保针对便携式应用的省电优化。

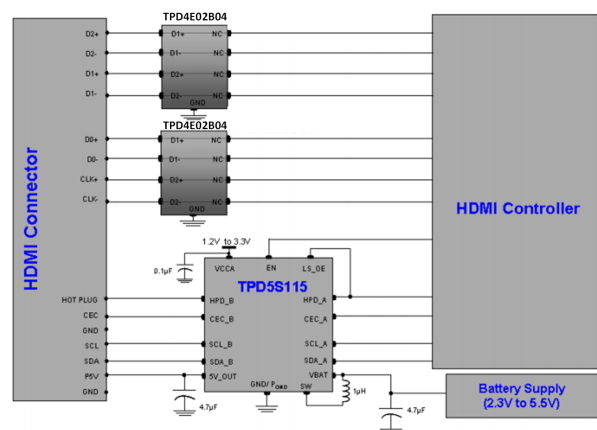
有 3 个适用于 SDA、SCL 和 CEC 线路的同相双向电压级转换电路。每个电路在 A 侧具有一个介于 1.1V 至 3.6V 之间的共同电源轨 (VCCA)。在 B 侧，SCL\_B 和 SDA\_B 各有一个被连接至经稳压 5V 电源轨 (5VOUT) 的内部 1.75kΩ 上拉电阻器。DDC (SCL\_B 和 SDA\_B) 引脚符合 I<sup>2</sup>C 技术规格，使用缓冲器可驱动高达 750pF 的负载。CEC\_B 引脚具有一个与内部 3.3V 电源相连的 27kΩ 上拉电阻器。TPD5S115 超过了 IEC61000-4-2 (4 级) ESD 保护级别。该器件采用节省空间的间距 0.4mm 的 1.72mm × 1.72mm YFF 封装。

器件信息<sup>(1)</sup>

| 器件型号     | 封装         | 封装尺寸 (标称值)      |
|----------|------------|-----------------|
| TPD5S115 | DSBGA (16) | 1.72mm × 1.72mm |

(1) 要了解所有可用封装，请见数据表末尾的可订购产品附录。

典型系统图



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## 4 修订历史记录

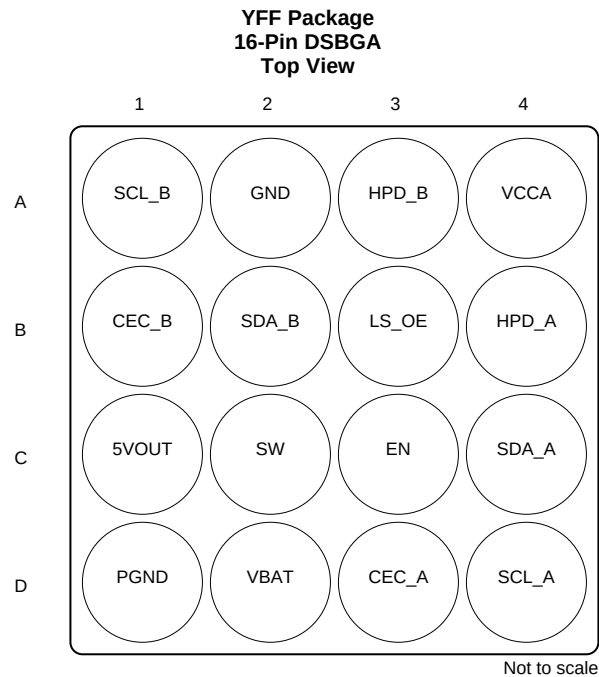
注：之前版本的页码可能与当前版本有所不同。

| Changes from Revision C (December 2016) to Revision D | Page |
|-------------------------------------------------------|------|
| • Updated Pinout image                                | 3    |

| Changes from Revision B (March 2013) to Revision C                                                                    | Page |
|-----------------------------------------------------------------------------------------------------------------------|------|
| • 已添加 器件信息表、引脚配置和功能部分、规格部分、ESD 额定值表、详细 说明部分、应用和实施部分、电源相关建议部分、布局部分、器件和文档支持部分以及机械、封装和可订购信息部分                            | 1    |
| • 已删除 订购信息表；请参见数据表末尾的 POA                                                                                             | 1    |
| • Added Thermal Information table                                                                                     | 5    |
| • Moved the passive components parameters from Recommended Operating Conditions table to the Output Capacitor section | 18   |

| Changes from Revision A (February 2013) to Revision B | Page |
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| • Changed Board Layout section                        | 21   |

## 5 Pin Configuration and Functions



### Pin Functions

| PIN             |        | TYPE <sup>(1)</sup> | DESCRIPTION                                                                                                                                                                                          |
|-----------------|--------|---------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME            | NO.    |                     |                                                                                                                                                                                                      |
| 5VOUT           | C1     | O                   | DC-DC output. The 5-V power pin can supply a 55-mA regulated current to the HDMI receiver. A separate DC-DC converter control pin (EN) disables the DC-DC converter when operating at low-power mode |
| CEC_A           | D3     | I/O                 | LS system side CEC bus I/O. This pin is bidirectional and referenced to VCCA                                                                                                                         |
| CEC_B           | B1     | I/O                 | LS HDMI connector side CEC bus I/O. This pin is bidirectional and referenced to the 3.3-V internal supply                                                                                            |
| EN              | C3     | C                   | DC-DC enable. Enables the DC-DC converter and HPD circuitry when EN is HIGH. The EN is referenced based off VCCA                                                                                     |
| GND             | A2     | G                   | Device ground                                                                                                                                                                                        |
| HPD_A           | B4     | O                   | System side output for the hot plug detect. This pin is unidirectional and is referenced to VCCA                                                                                                     |
| HPD_B           | A3     | I                   | HDMI side input for the hot plug detect. This pin is unidirectional and is referenced to 5VOUT                                                                                                       |
| LS_OE           | B3     | C                   | Level shifter enable. This pin is referenced to VCCA. Enables level shifters and LDO when EN is HIGH and LS_OE is HIGH                                                                               |
| PGND            | D1     | G                   | DC-DC converter ground. These pins are isolated from the GND pins. This pin should be tied to system GND                                                                                             |
| SCL_A,<br>SDA_A | D4, C4 | I/O                 | LS system side input and output for I <sup>2</sup> C Bus. These pins are bidirectional and referenced to VCCA                                                                                        |
| SCL_B,<br>SDA_B | A1, B2 | I/O                 | LS HDMI side connector side input and output for I <sup>2</sup> C Bus. These pins are bidirectional and referenced to 5VOUT                                                                          |
| SW              | C2     | I                   | Switch input. This pin is the inductor input for the DC-DC converter                                                                                                                                 |
| VBAT            | D2     | P                   | Battery supply. This voltage is typically 2.3 V to 5.5 V                                                                                                                                             |
| VCCA            | A4     | P                   | System side supply. This voltage is typically 1.2 V to 3.3 V from the core microcontroller                                                                                                           |

(1) C = Control, G = Ground, I = Input, O = Output, P = Power

## 6 Specifications

### 6.1 Absolute Maximum Ratings

 over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                                                                                              |                            | MIN  | MAX         | UNIT |
|----------------------------------------------------------------------------------------------|----------------------------|------|-------------|------|
| Supply voltage                                                                               | VCCA                       |      | 4           | V    |
|                                                                                              | VBAT                       | −0.3 | 6           | V    |
| Input voltage, $V_I$ <sup>(2)</sup>                                                          | SCL_A, SDA_A, CEC_A        | −0.3 | 4           | V    |
|                                                                                              | SCL_B, SDA_B, CEC_B, HPD_B | −0.3 | 6           |      |
|                                                                                              | EN, LS_OE                  | −0.3 | 4           |      |
| Voltage applied to any output in the high-impedance or power-off state, $V_O$ <sup>(2)</sup> | SCL_A, SDA_A, CEC_A        | −0.3 | 4           | V    |
|                                                                                              | SCL_B, SDA_B, CEC_B        | −0.3 | 6           |      |
| Voltage applied to any output in the high or low state, $V_O$ <sup>(2)</sup>                 | SCL_A, SDA_A, CEC_A        | −0.3 | VCCA + 0.3  | V    |
|                                                                                              | SCL_B, SDA_B, CEC_B        | −0.3 | 5VOUT + 0.3 |      |
| Input clamp current ( $I_V < 0$ )                                                            |                            |      | −50         | mA   |
| Output clamp current ( $V_O < 0$ )                                                           |                            |      | −50         | mA   |
| Continuous current through 5VOUT, or GND                                                     |                            |      | ±100        | mA   |
| Storage temperature, $T_{stg}$                                                               |                            | −65  | 150         | °C   |

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

### 6.2 ESD Ratings

|                                     |                                                                                |                                                 | VALUE  | UNIT |
|-------------------------------------|--------------------------------------------------------------------------------|-------------------------------------------------|--------|------|
| $V_{(ESD)}$ Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | All pins except pins 4A, B3, C3, C4, D3, and D4 | 500    | V    |
|                                     |                                                                                | Pins 4A, B3, C3, C4, D3, and D4                 | 2000   |      |
|                                     | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> |                                                 | 1000   |      |
|                                     | IEC 61000-4-2 Contact Discharge                                                | Pins A1, A3, B1, B2, and C1                     | ±14000 |      |
|                                     | IEC 61000-4-2 Air-gap Discharge                                                | Pins A1, A3, B1, B2, and C1                     | ±16000 |      |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|           |                          |                       | MIN          | NOM                                         | MAX                             | UNIT |
|-----------|--------------------------|-----------------------|--------------|---------------------------------------------|---------------------------------|------|
| $V_{CCA}$ | Supply voltage, VCCA     |                       | 1.2          |                                             | 3.6                             | V    |
| $V_{BAT}$ | Supply voltage, VBAT     |                       | 2.3          |                                             | 5.5                             | V    |
| $V_{IH}$  | High-level input voltage | VCCA = 1.2 V to 3.6 V | SCL_A, SDA_A | $0.7 \times V_{CCA}$                        | $V_{CCA}$                       | V    |
|           |                          |                       | CEC_A        | $0.7 \times V_{CCA}$                        | $V_{CCA}$                       |      |
|           |                          |                       | EN, LS_OE    | 1                                           | $V_{CCA}$                       |      |
|           | 5VOUT = 5 V              |                       | SCL_B, SDA_B | $0.7 \times 5VOUT$                          | 5VOUT                           |      |
|           |                          |                       | CEC_B        | $0.7 \times 3.3 \text{ V (internal)}^{(1)}$ | 3.3 V (internal) <sup>(1)</sup> |      |
|           |                          |                       | HPD_B        | 2                                           |                                 |      |

(1) 3.3 V (internal) is an internally generated voltage node for the CEC\_B output buffer supply reference. An LDO generates this 3.3 V from 5VOUT when LS\_OE and EN are HIGH.

## Recommended Operating Conditions (continued)

over operating free-air temperature range (unless otherwise noted)

|                    |                                                                   |                                             | MIN          | NOM                  | MAX                                           | UNIT |
|--------------------|-------------------------------------------------------------------|---------------------------------------------|--------------|----------------------|-----------------------------------------------|------|
| $V_{IL}$           | Low-Level input voltage                                           | $V_{CCA} = 1.2 \text{ V to } 3.6 \text{ V}$ | SCL_A, SDA_A | –0.5                 | $0.082 \times V_{CCA}$                        | V    |
|                    |                                                                   |                                             | CEC_A        | –0.5                 | $0.082 \times V_{CCA}$                        |      |
|                    |                                                                   |                                             | EN, LS_OE    | –0.5                 | 0.4                                           |      |
|                    | $5V_{OUT} = 5 \text{ V}$                                          |                                             | SCL_B, SDA_B | –0.5                 | $0.3 \times 5V_{OUT}$                         |      |
|                    |                                                                   |                                             | CEC_B        | –0.5                 | $0.3 \times 3.3$<br>(internal) <sup>(1)</sup> |      |
|                    |                                                                   |                                             | HPD_B        | 0                    | 0.8                                           |      |
| $V_{ILC}$          | Low-level input voltage                                           |                                             |              | –0.5                 | $0.065 \times V_{CCA}$                        | V    |
| $V_{OL} - V_{ILC}$ | Delta between $V_{OL}$ and $V_{ILC}$ ( $V_{IO} = 2.5 \text{ V}$ ) |                                             |              | $0.1 \times V_{CCA}$ |                                               | V    |
| $T_A$              | Operating free-air temperature                                    |                                             |              | –40                  | 85                                            | °C   |

## 6.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | TPD5S115    | UNIT |
|-------------------------------|----------------------------------------------|-------------|------|
|                               |                                              | YFF (DSBGA) |      |
|                               |                                              | 16 PINS     |      |
| $R_{\theta JA}$               | Junction-to-ambient thermal resistance       | 78.2        | °C/W |
| $R_{\theta JC(top)}$          | Junction-to-case (top) thermal resistance    | 0.6         | °C/W |
| $R_{\theta JB}$               | Junction-to-board thermal resistance         | 13.2        | °C/W |
| $\psi_{JT}$                   | Junction-to-top characterization parameter   | 2.5         | °C/W |
| $\psi_{JB}$                   | Junction-to-board characterization parameter | 13          | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 6.5 Electrical Characteristics

$T_A = -40^\circ\text{C}$  to  $85^\circ\text{C}$  (unless otherwise noted)

| PARAMETER             |                                                          |                             | TEST CONDITIONS                                                                                | MIN                     | TYP | MAX | UNIT |
|-----------------------|----------------------------------------------------------|-----------------------------|------------------------------------------------------------------------------------------------|-------------------------|-----|-----|------|
| V <sub>OHA</sub>      |                                                          |                             | I <sub>OH</sub> = −10 μA, V <sub>I</sub> = V <sub>IH</sub> , V <sub>CCA</sub> = 1.2 V to 3.6 V | V <sub>CCA</sub> × 0.8  |     |     | V    |
| V <sub>OLA</sub>      |                                                          |                             | I <sub>OL</sub> = 10 μA, V <sub>I</sub> = V <sub>IL</sub> , V <sub>CCA</sub> = 1.2 V to 3.6 V  | V <sub>CCA</sub> × 0.16 |     |     | V    |
| V <sub>OHB</sub>      |                                                          |                             | I <sub>OH</sub> = −10 μA, V <sub>I</sub> = V <sub>IH</sub>                                     |                         |     |     | V    |
| V <sub>OLB</sub>      |                                                          |                             | I <sub>OL</sub> = 3 mA, V <sub>I</sub> = V <sub>IL</sub>                                       | 0.4                     |     |     | V    |
| R <sub>PU</sub>       | Internal pullup                                          | SCL_A, SDA_A                | Pullup connected to VCCA rail                                                                  | 10                      |     |     | kΩ   |
|                       |                                                          | SCL_B, SDA_B                | Pullup connected to 5-V rail                                                                   | 1.75                    |     |     |      |
| I <sub>PULLUPAC</sub> | Transient boosted pullup current (rise-time accelerator) | SCL_B, SDA_B                | Pullup connected to 5-V rail                                                                   | 15                      |     |     | mA   |
| I <sub>OFF</sub>      | Leakage current                                          | A port                      | V <sub>CCA</sub> = 0 V, V <sub>I</sub> or V <sub>O</sub> = 0 to 3.6 V, V <sub>CCA</sub> = 0 V  | ±5                      |     |     | μA   |
|                       |                                                          | B port                      | 5VOUT = 0 V, V <sub>I</sub> or V <sub>O</sub> = 0 to 5.5 V, V <sub>CCA</sub> = 0 V to 3.6 V    | ±5                      |     |     |      |
| I <sub>OZ</sub>       |                                                          | A port                      | V <sub>O</sub> = V <sub>CCO</sub> or GND, V <sub>CCA</sub> = 1.2 V to 3.6 V                    | ±5                      |     |     |      |
|                       |                                                          | B port                      | V <sub>I</sub> = V <sub>CCI</sub> or GND, V <sub>CCA</sub> = 1.2 V to 3.6 V                    | ±5                      |     |     |      |
| C <sub>L</sub>        | Bus load capacitance                                     | A port                      |                                                                                                | 15                      |     |     | pF   |
|                       |                                                          | B port                      |                                                                                                | 750                     |     |     |      |
| SUPPLY CURRENT        |                                                          |                             |                                                                                                |                         |     |     |      |
| I <sub>CCA</sub>      | VCCA supply current                                      | Standby                     | I/Os = HIGH                                                                                    | 2                       |     |     | μA   |
|                       |                                                          | Active                      | I/Os = HIGH                                                                                    | 15                      |     |     | μA   |
| I <sub>CCB</sub>      | VBAT supply current                                      | Standby                     | EN = LOW, LS_OE = LOW                                                                          | 0.5                     |     |     | μA   |
|                       |                                                          | DC-DC and HPD active        | EN = HIGH, LS_OE = LOW                                                                         | 30 50                   |     |     | μA   |
|                       |                                                          | DC-DC, HPD, DDC, CEC Active | EN = HIGH, LS_OE = LOW, I/Os = HIGH                                                            | 225 300                 |     |     | μA   |

## Electrical Characteristics (continued)

 $T_A = -40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$  (unless otherwise noted)

| PARAMETER                                        |                                                 |                                                                                                                       | TEST CONDITIONS                                                                                         | MIN                     | TYP | MAX              | UNIT             |
|--------------------------------------------------|-------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------|-------------------------|-----|------------------|------------------|
| DC-DC CONVERTER                                  |                                                 |                                                                                                                       |                                                                                                         |                         |     |                  |                  |
| V <sub>BAT</sub>                                 | Input voltage                                   |                                                                                                                       |                                                                                                         | 2.3                     |     | 5.5              | V                |
| V <sub>OUT</sub>                                 | Total DC output voltage <sup>(1)</sup>          |                                                                                                                       |                                                                                                         | 4.9                     | 5   | 5.13             | V                |
| T <sub>OVA</sub>                                 | Total output voltage accuracy <sup>(2)</sup>    |                                                                                                                       |                                                                                                         | 4.8                     | 5   | 5.3              | V                |
| V <sub>IO_Ripple</sub>                           | Output voltage ripple, loaded                   |                                                                                                                       | I <sub>O</sub> = 65 mA                                                                                  | 50.6                    |     |                  | mV <sub>PP</sub> |
|                                                  |                                                 |                                                                                                                       | I <sub>O</sub> = 150 mA                                                                                 | 16                      |     |                  |                  |
| f <sub>CLK</sub>                                 | Internal operating frequency                    |                                                                                                                       | V <sub>BAT</sub> = 2.3 V to 5.5 V                                                                       | 3.5                     |     |                  | MHz              |
| t <sub>START</sub>                               | Start-up time                                   |                                                                                                                       | From EN input to 5-V power output 90% point                                                             | 187                     |     |                  | μs               |
| I <sub>O</sub>                                   | Output current                                  |                                                                                                                       | V <sub>BAT</sub> = 2.3 V to 5.5 V                                                                       | 55                      |     |                  | mA               |
|                                                  | Reverse leakage current, V <sub>O</sub>         |                                                                                                                       | EN = LOW, V <sub>O</sub> = 5.5 V                                                                        | 2.5                     |     |                  | μA               |
|                                                  | Leakage current from battery to V <sub>O</sub>  |                                                                                                                       | EN = LOW                                                                                                | 5                       |     |                  | μA               |
| V <sub>BATUV</sub>                               | Undervoltage lockout threshold                  |                                                                                                                       | Falling                                                                                                 | 2                       |     |                  | V                |
|                                                  |                                                 |                                                                                                                       | Rising                                                                                                  | 2.1                     |     |                  | V                |
| Line transient response                          |                                                 | V <sub>BAT</sub> = 3.4 V, I <sub>O</sub> = 20 mA to 65 mA, A 217 Hz, 600 mV <sub>PP</sub> square wave pulse           | 17.1                                                                                                    |                         |     | mV <sub>pk</sub> |                  |
| Load transient response                          |                                                 | V <sub>BAT</sub> = 3.4 V, I <sub>O</sub> = 5 mA to 65 mA, 10-μs pulse, t <sub>RISE</sub> = t <sub>FALL</sub> = 0.1 μs | 63.5                                                                                                    |                         |     | mV <sub>pk</sub> |                  |
| I <sub>INRUSH</sub>                              | Inrush current, average over t <sub>START</sub> |                                                                                                                       | V <sub>BAT</sub> = 2.3 V to 5.5 V, I <sub>OUT</sub> = 65 mA                                             | 168                     |     |                  | mA               |
| I <sub>SC</sub>                                  | Short-circuit current limit from output         |                                                                                                                       |                                                                                                         | 90                      |     |                  | mA               |
| VOLTAGE LEVEL SHIFTER CEC LINE (x_A & x_B PORTS) |                                                 |                                                                                                                       |                                                                                                         |                         |     |                  |                  |
| V <sub>OHA</sub>                                 |                                                 |                                                                                                                       | I <sub>OH</sub> = −10 μA, V <sub>I</sub> = V <sub>IH</sub> , V <sub>CCA</sub> = 1.2 V to 3.6 V          | V <sub>CCA</sub> × 0.8  |     |                  | V                |
| V <sub>OLA</sub>                                 |                                                 |                                                                                                                       | I <sub>OL</sub> = 10 μA, V <sub>I</sub> = V <sub>IL</sub> , V <sub>CCA</sub> = 1.2 V to 3.6 V           | V <sub>CCA</sub> × 0.16 |     |                  | V                |
| V <sub>OHB</sub>                                 |                                                 |                                                                                                                       | I <sub>OH</sub> = −20 μA, V <sub>I</sub> = V <sub>IH</sub>                                              | V <sub>CCA</sub> × 0.8  |     |                  | V                |
| V <sub>OLB</sub>                                 |                                                 |                                                                                                                       | I <sub>OL</sub> = 3 mA, V <sub>I</sub> = V <sub>IL</sub>                                                | 0.4                     |     |                  | V                |
| R <sub>PU</sub>                                  | Internal pullup                                 | CEC_A                                                                                                                 | Pullup connected to V <sub>CCA</sub> rail                                                               | 10                      |     |                  | kΩ               |
|                                                  |                                                 | CEC_B                                                                                                                 | Pullup connected to 3.3 V rail                                                                          | 22                      |     |                  |                  |
| R <sub>PD</sub>                                  | Internal pulldown                               | CEC_B                                                                                                                 | Pullup connected to GND                                                                                 | 14                      |     |                  | MΩ               |
| I <sub>OFF</sub>                                 | A port                                          |                                                                                                                       | V <sub>CCA</sub> = 0 V, V <sub>I</sub> or V <sub>O</sub> = 0 to 3.6 V, V <sub>CCA</sub> = 0 V           | ±5                      |     |                  | μA               |
|                                                  | B port                                          |                                                                                                                       | 5V <sub>OUT</sub> = 0 V, V <sub>I</sub> or V <sub>O</sub> = 0 to 5.5 V, V <sub>CCA</sub> = 0 V to 3.6 V | ±1.8                    |     |                  |                  |
| I <sub>OZ</sub>                                  | A port                                          |                                                                                                                       | V <sub>O</sub> = V <sub>CCO</sub> or GND, V <sub>CCA</sub> = 1.2 V to 3.6 V                             | ±5                      |     |                  |                  |
|                                                  | B port                                          |                                                                                                                       | V <sub>I</sub> = V <sub>CCI</sub> or GND, V <sub>CCA</sub> = 1.2 V to 3.6 V                             | ±5                      |     |                  |                  |
| VOLTAGE LEVEL SHIFTER - HPD LINE (X_A & x_B)     |                                                 |                                                                                                                       |                                                                                                         |                         |     |                  |                  |
| V <sub>OHA</sub>                                 |                                                 |                                                                                                                       | I <sub>OH</sub> = −3 mA, V <sub>I</sub> = V <sub>IH</sub> , V <sub>CCA</sub> = 1.2 V to 3.6 V           | V <sub>CCA</sub> × 0.7  |     |                  | V                |
| V <sub>OLA</sub>                                 |                                                 |                                                                                                                       | I <sub>OL</sub> = 3 mA, V <sub>I</sub> = V <sub>IL</sub> , V <sub>CCA</sub> = 1.2 V to 3.6 V            | 0.4                     |     |                  | V                |
| R <sub>PD</sub>                                  | Internal pulldown                               | HPD_B                                                                                                                 | Pullup connected to GND                                                                                 | 100                     |     |                  | kΩ               |
| I <sub>OZ</sub>                                  | A port                                          |                                                                                                                       | V <sub>I</sub> = V <sub>CCI</sub> or GND, V <sub>CCA</sub> = 3.6 V                                      | ±5                      |     |                  | μA               |
| LS_OE, EN                                        |                                                 |                                                                                                                       |                                                                                                         |                         |     |                  |                  |
| I <sub>I</sub>                                   |                                                 |                                                                                                                       | V <sub>I</sub> = V <sub>CCA</sub> or GND, V <sub>CCA</sub> = 1.2 V to 3.6 V                             | ±12                     |     |                  |                  |

(1) Includes voltage references, DC load and line regulations, process and temperature.

(2) Includes voltage references, DC load and line regulations, transient load and line regulations, ripple, process, and temperature.

## 6.6 Electrical Characteristics – I/O Capacitances

over operating free-air temperature range (unless otherwise noted)

| PARAMETER   |                     | TEST CONDITIONS                                                                      |                                                                               | MIN | TYP | MAX | UNIT |
|-------------|---------------------|--------------------------------------------------------------------------------------|-------------------------------------------------------------------------------|-----|-----|-----|------|
| Capacitance | EN, LS_OE           | $V_{BIAS} = 1.8\text{ V}$ , $f = 1\text{ MHz}$ ,<br>30-mV <sub>pp</sub> AC signal    | $V_{CCA} = 3.6\text{ V}$ , $V_{BAT} = 5\text{ V}$                             |     | 7.1 | 9.5 | pF   |
|             | SCL_A, SDA_A, CEC_A |                                                                                      | $V_{CCA} = 3.6\text{ V}$ , $V_{BAT} = 5\text{ V}$ , EN = LOW                  |     | 7   |     | pF   |
|             | HPD_A, HPD_B        |                                                                                      | $V_{CCA} = 3.6\text{ V}$ , $V_{BAT} = 5\text{ V}$ , EN = LOW                  |     | 4   |     | pF   |
|             | SCL_B, SDA_B        | $V_{BIAS} = 2.5\text{ V}$ , $f = 100\text{ kHz}$ ,<br>3.5-V <sub>pp</sub> AC signal  | $V_{CCA} = 3.6\text{ V}$ , $V_{BAT} = 5\text{ V}$ , EN = LOW,<br>LS_OE = HIGH |     | 10  |     | pF   |
|             | CEC_B               | $V_{BIAS} = 1.65\text{ V}$ , $f = 100\text{ kHz}$ ,<br>2.5-V <sub>pp</sub> AC signal | $V_{CCA} = 3.6\text{ V}$ , $V_{BAT} = 5\text{ V}$ , EN = LOW,<br>LS_OE = HIGH |     | 7   |     | pF   |
|             | CEC_B               |                                                                                      | $V_{CCA} = 0\text{ V}$ , 5V_IN = 0 V                                          |     | 7   |     | pF   |

## 6.7 Switching Characteristics – $V_{CCA} = 1.2\text{ V}$

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                           |                               | TEST CONDITIONS |                      | MIN  | TYP | MAX | UNIT |
|-------------------------------------|-------------------------------|-----------------|----------------------|------|-----|-----|------|
| SCL and SDA LINES (x_A & x_B PORTS) |                               |                 |                      |      |     |     |      |
| t <sub>PHL</sub>                    | High-to-low propagation delay | A to B          | DDC channels enabled | 394  |     | ns  |      |
|                                     |                               | B to A          | DDC channels enabled | 347  |     |     |      |
| t <sub>PLH</sub>                    | Low-to-high propagation delay | A to B          | DDC channels enabled | 504  |     | ns  |      |
|                                     |                               | B to A          | DDC channels enabled | 171  |     |     |      |
| t <sub>FALL</sub>                   | Fall time                     | A port          | DDC channels enabled | 146  |     | ns  |      |
|                                     |                               | B port          | DCC channels enabled | 135  |     |     |      |
| t <sub>RISE</sub>                   | Rise time                     | A port          | DCC channels enabled | 190  |     | ns  |      |
|                                     |                               | B port          | DCC channels enabled | 93   |     |     |      |
| f <sub>MAX</sub>                    | Maximum switching frequency   |                 | DCC channels enabled | 400  |     | kHz |      |
| CEC LINE (x_A & x_B PORTS)          |                               |                 |                      |      |     |     |      |
| t <sub>PHL</sub>                    | High-to-low propagation delay | A to B          | CEC channels enabled | 550  |     | ns  |      |
|                                     |                               | B to A          | CEC channels enabled | 350  |     |     |      |
| t <sub>PLH</sub>                    | Low-to-high propagation delay | A to B          | CEC channels enabled | 13   |     | μs  |      |
|                                     |                               | B to A          | CEC channels enabled | 290  |     |     |      |
| t <sub>FALL</sub>                   | Fall time                     | A port          | CEC channels enabled | 146  |     | ns  |      |
|                                     |                               | B port          | CEC channels enabled | 200  |     |     |      |
| t <sub>RISE</sub>                   | Rise time                     | A port          | CEC channels enabled | 190  |     | ns  |      |
|                                     |                               | B port          | CEC channels enabled | 16.4 |     |     |      |
| HPD LINE (x_A & x_B PORTS)          |                               |                 |                      |      |     |     |      |
| t <sub>PHL</sub>                    | Propagation delay             | B to A          | CEC channels enabled | 10.4 |     | ns  |      |
| t <sub>PLH</sub>                    | Low-to-high propagation delay | B to A          | CEC channels enabled | 9.9  |     | ns  |      |
| t <sub>FALL</sub>                   | Fall time                     | A port          | CEC channels enabled | 0.7  |     | ns  |      |
| t <sub>RISE</sub>                   | Rise time                     | A port          | CEC channels enabled | 0.8  |     | ns  |      |

## 6.8 Switching Characteristics – $V_{CCA} = 1.5\text{ V}$

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                        |                               | TEST CONDITIONS |                      | MIN | TYP  | MAX | UNIT |
|----------------------------------|-------------------------------|-----------------|----------------------|-----|------|-----|------|
| SCL, SDA LINES (x_A & x_B PORTS) |                               |                 |                      |     |      |     |      |
| t <sub>PHL</sub>                 | High-to-low propagation delay | A to B          | DDC channels enabled |     | 375  |     | ns   |
|                                  |                               | B to A          | DDC channels enabled |     | 272  |     |      |
| t <sub>PLH</sub>                 | Low-to-high propagation delay | A to B          | DDC channels enabled |     | 488  |     | ns   |
|                                  |                               | B to A          | DDC channels enabled |     | 166  |     |      |
| t <sub>FALL</sub>                | Fall time                     | A port          | DDC channels enabled |     | 114  |     | ns   |
|                                  |                               | B port          | DCC channels enabled |     | 135  |     |      |
| t <sub>RISE</sub>                | Rise time                     | A port          | DCC channels enabled |     | 186  |     | ns   |
|                                  |                               | B port          | DCC channels enabled |     | 93   |     |      |
| f <sub>MAX</sub>                 | Maximum switching frequency   |                 | DCC channels enabled |     | 400  |     | kHz  |
| CEC Line (x_A & x_B Ports)       |                               |                 |                      |     |      |     |      |
| t <sub>PHL</sub>                 | High-to-low propagation delay | A to B          | CEC channels enabled |     | 536  |     | ns   |
|                                  |                               | B to A          | CEC channels enabled |     | 272  |     |      |
| t <sub>PLH</sub>                 | Low-to-high propagation delay | A to B          | CEC channels enabled |     | 13   |     | μs   |
|                                  |                               | B to A          | CEC channels enabled |     | 285  |     | ns   |
| t <sub>FALL</sub>                | Fall time                     | A port          | CEC channels enabled |     | 113  |     | ns   |
|                                  |                               | B port          | CEC channels enabled |     | 201  |     |      |
| t <sub>RISE</sub>                | Rise time                     | A port          | CEC channels enabled |     | 187  |     | ns   |
|                                  |                               | B port          | CEC channels enabled |     | 16   |     | μs   |
| HPD LINE (x_A & x_B PORTS)       |                               |                 |                      |     |      |     |      |
| t <sub>PHL</sub>                 | High-to-low propagation delay | B to A          | CEC channels enabled |     | 10   |     | ns   |
| t <sub>PLH</sub>                 | Low-to-high propagation delay | B to A          | CEC channels enabled |     | 10   |     | ns   |
| t <sub>FALL</sub>                | Fall time                     | A port          | CEC channels enabled |     | 0.46 |     | ns   |
| t <sub>RISE</sub>                | Rise time                     | A port          | CEC channels enabled |     | 0.5  |     | ns   |

## 6.9 Switching Characteristics – $V_{CCA} = 1.8\text{ V}$

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                                   |                               | TEST CONDITIONS      | MIN                  | TYP | MAX | UNIT          |
|---------------------------------------------|-------------------------------|----------------------|----------------------|-----|-----|---------------|
| <b>SCL, SDA LINES (x_A &amp; x_B PORTS)</b> |                               |                      |                      |     |     |               |
| $t_{PHL}$                                   | High-to-low propagation delay | A to B               | DDC channels enabled | 370 |     | ns            |
|                                             |                               | B to A               | DDC channels enabled | 230 |     |               |
| $t_{PLH}$                                   | Low-to-high propagation delay | A to B               | DDC channels enabled | 480 |     | ns            |
|                                             |                               | B to A               | DDC channels enabled | 163 |     |               |
| $t_{FALL}$                                  | Fall time                     | A port               | DDC channels enabled | 100 |     | ns            |
|                                             |                               | B port               | DCC channels enabled | 135 |     |               |
| $t_{RISE}$                                  | Rise time                     | A port               | DCC channels enabled | 180 |     | ns            |
|                                             |                               | B port               | DCC channels enabled | 93  |     |               |
| $f_{MAX}$                                   | Maximum switching frequency   | DCC channels enabled | 400                  |     |     | kHz           |
| <b>CEC LINE (x_A &amp; x_B PORTS)</b>       |                               |                      |                      |     |     |               |
| $t_{PHL}$                                   | High-to-low propagation delay | A to B               | CEC channels enabled | 530 |     | ns            |
|                                             |                               | B to A               | CEC channels enabled | 230 |     |               |
| $t_{PLH}$                                   | Low-to-high propagation delay | A to B               | CEC channels enabled | 13  |     | $\mu\text{s}$ |
|                                             |                               | B to A               | CEC channels enabled | 280 |     | ns            |
| $t_{FALL}$                                  | Fall time                     | A port               | CEC channels enabled | 98  |     | ns            |
|                                             |                               | B port               | CEC channels enabled | 200 |     |               |



## Switching Characteristics – $V_{CCA} = 1.8\text{ V}$ (continued)

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                  |                               | TEST CONDITIONS |                      | MIN | TYP  | MAX | UNIT |
|----------------------------|-------------------------------|-----------------|----------------------|-----|------|-----|------|
| t <sub>RISE</sub>          | Rise time                     | A port          | CEC channels enabled |     | 180  |     | ns   |
|                            |                               | B port          | CEC channels enabled |     | 16   |     | μs   |
| HPD LINE (x_A & x_B PORTS) |                               |                 |                      |     |      |     |      |
| t <sub>PHL</sub>           | High-to-low propagation delay | B to A          | CEC channels enabled |     | 10   |     | ns   |
| t <sub>PLH</sub>           | Low-to-high propagation delay | B to A          | CEC channels enabled |     | 10   |     | ns   |
| t <sub>FALL</sub>          | Fall time                     | A port          | CEC channels enabled |     | 0.41 |     | ns   |
| t <sub>RISE</sub>          | Rise time                     | A port          | CEC channels enabled |     | 0.41 |     | ns   |

## 6.10 Switching Characteristics – $V_{CCA} = 2.5\text{ V}$

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                        |                               | TEST CONDITIONS |                      | MIN  | TYP | MAX | UNIT |
|----------------------------------|-------------------------------|-----------------|----------------------|------|-----|-----|------|
| SCL, SDA LINES (x_A & x_B PORTS) |                               |                 |                      |      |     |     |      |
| t <sub>PHL</sub>                 | High-to-low propagation delay | A to B          | DDC channels enabled | 370  |     | ns  |      |
|                                  |                               | B to A          | DDC channels enabled | 185  |     |     |      |
| t <sub>PLH</sub>                 | Low-to-high propagation delay | A to B          | DDC channels enabled | 467  |     | ns  |      |
|                                  |                               | B to A          | DDC channels enabled | 160  |     |     |      |
| t <sub>FALL</sub>                | Fall time                     | A port          | DDC channels enabled | 80   |     | ns  |      |
|                                  |                               | B port          | DCC channels enabled | 135  |     |     |      |
| t <sub>RISE</sub>                | Rise time                     | A port          | DCC channels enabled | 179  |     | ns  |      |
|                                  |                               | B port          | DCC channels enabled | 93   |     |     |      |
| f <sub>MAX</sub>                 | Maximum switching frequency   |                 | DCC channels enabled | 400  |     | kHz |      |
| CEC LINE (x_A & x_B PORTS)       |                               |                 |                      |      |     |     |      |
| t <sub>PHL</sub>                 | High-to-low propagation delay | A to B          | CEC channels enabled | 530  |     | ns  |      |
|                                  |                               | B to A          | CEC channels enabled | 185  |     |     |      |
| t <sub>PLH</sub>                 | Low-to-high propagation delay | A to B          | CEC channels enabled | 13   |     | μs  |      |
|                                  |                               | B to A          | CEC channels enabled | 275  |     |     |      |
| t <sub>FALL</sub>                | Fall time                     | A port          | CEC channels enabled | 80   |     | ns  |      |
|                                  |                               | B port          | CEC channels enabled | 200  |     |     |      |
| t <sub>RISE</sub>                | Rise time                     | A port          | CEC channels enabled | 180  |     | ns  |      |
|                                  |                               | B port          | CEC channels enabled | 16   |     |     |      |
| HPD LINE (x_A & x_B PORTS)       |                               |                 |                      |      |     |     |      |
| t <sub>PHL</sub>                 | High-to-low propagation delay | B to A          | CEC channels enabled | 10   |     | ns  |      |
| t <sub>PLH</sub>                 | Low-to-high propagation delay | B to A          | CEC channels enabled | 10   |     | ns  |      |
| t <sub>FALL</sub>                | Fall time                     | A port          | CEC channels enabled | 0.35 |     | ns  |      |
| t <sub>RISE</sub>                | Rise time                     | A port          | CEC channels enabled | 0.35 |     | ns  |      |

## 6.11 Switching Characteristics – $V_{CCA} = 3.3\text{ V}$

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                        |                               | TEST CONDITIONS |                      | MIN | TYP  | MAX | UNIT |
|----------------------------------|-------------------------------|-----------------|----------------------|-----|------|-----|------|
| SCL, SDA LINES (x_A & x_B PORTS) |                               |                 |                      |     |      |     |      |
| t <sub>PHL</sub>                 | High-to-low propagation delay | A to B          | DDC channels enabled |     | 370  |     | ns   |
|                                  |                               | B to A          | DDC channels enabled |     | 160  |     |      |
| t <sub>PLH</sub>                 | Low-to-high propagation delay | A to B          | DDC channels enabled |     | 460  |     | ns   |
|                                  |                               | B to A          | DDC channels enabled |     | 155  |     |      |
| t <sub>FALL</sub>                | Fall time                     | A port          | DDC channels enabled |     | 75   |     | ns   |
|                                  |                               | B port          | DCC channels enabled |     | 135  |     |      |
| t <sub>RISE</sub>                | Rise time                     | A port          | DCC channels enabled |     | 180  |     | ns   |
|                                  |                               | B port          | DCC channels enabled |     | 93   |     |      |
| f <sub>MAX</sub>                 | Maximum switching frequency   |                 | DCC channels enabled |     | 400  |     | kHz  |
| CEC LINE (x_A & x_B PORTS)       |                               |                 |                      |     |      |     |      |
| t <sub>PHL</sub>                 | High-to-low propagation delay | A to B          | CEC channels enabled |     | 530  |     | ns   |
|                                  |                               | B to A          | CEC channels enabled |     | 160  |     |      |
| t <sub>PLH</sub>                 | Low-to-high propagation delay | A to B          | CEC channels enabled |     | 13   |     | μs   |
|                                  |                               | B to A          | CEC channels enabled |     | 275  |     | ns   |
| t <sub>FALL</sub>                | Fall time                     | A port          | CEC channels enabled |     | 73   |     | ns   |
|                                  |                               | B port          | CEC channels enabled |     | 200  |     |      |
| t <sub>RISE</sub>                | Rise time                     | A port          | CEC channels enabled |     | 180  |     | ns   |
|                                  |                               | B port          | CEC channels enabled |     | 16   |     | μs   |
| HPD LINE (x_A & x_B PORTS)       |                               |                 |                      |     |      |     |      |
| t <sub>PHL</sub>                 | High-to-low propagation delay | B to A          | CEC channels enabled |     | 10   |     | ns   |
| t <sub>PLH</sub>                 | Low-to-high propagation delay | B to A          | CEC channels enabled |     | 10   |     | ns   |
| t <sub>FALL</sub>                | Fall time                     | A port          | CEC channels enabled |     | 0.34 |     | ns   |
| t <sub>RISE</sub>                | Rise time                     | A port          | CEC channels enabled |     | 0.36 |     | ns   |

## 6.12 Typical Characteristics

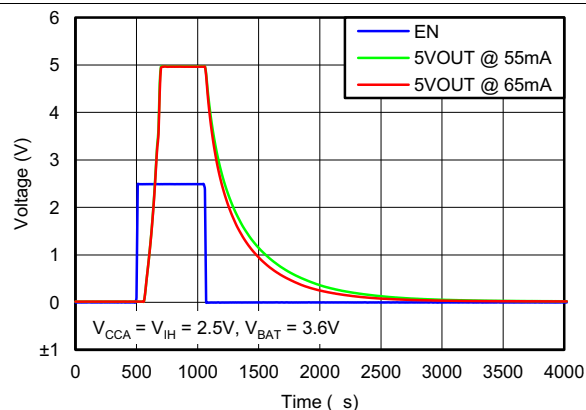


Figure 1. Voltage vs Time

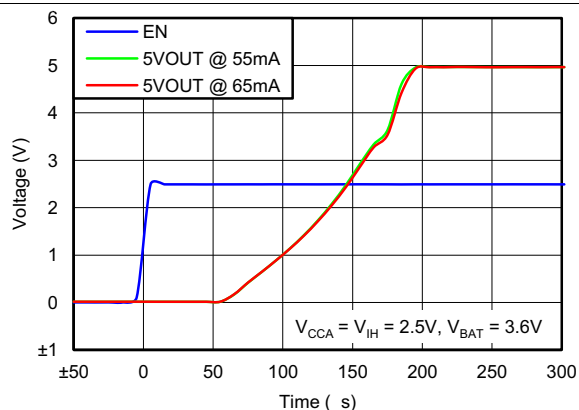


Figure 2. Voltage vs Time

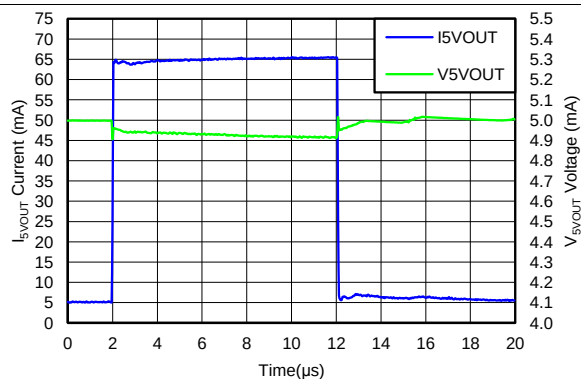


Figure 3. Current vs Time

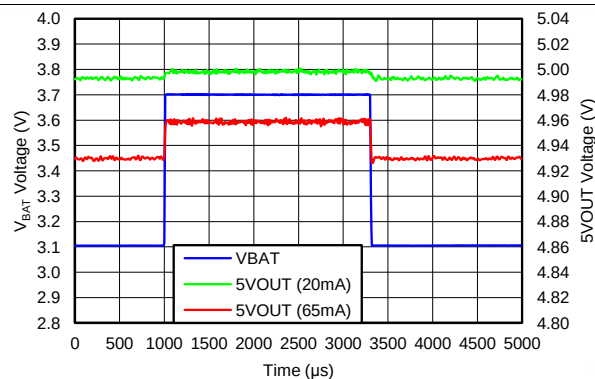


Figure 4. Voltage vs Time

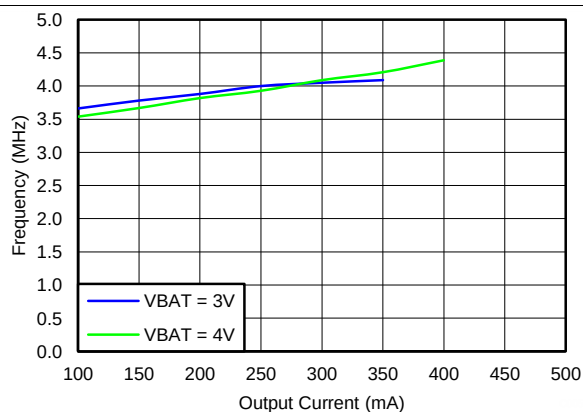


Figure 5. Frequency vs Output Current

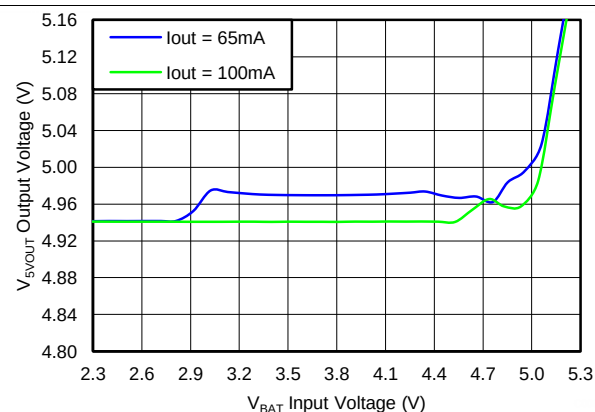


Figure 6. Output Voltage vs Input Voltage

## Typical Characteristics (continued)

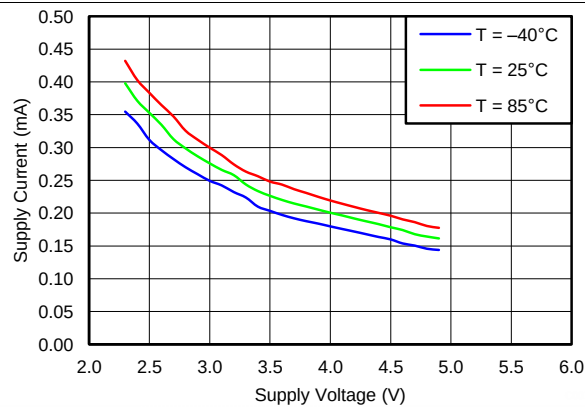


Figure 7. Supply Current vs Supply Voltage

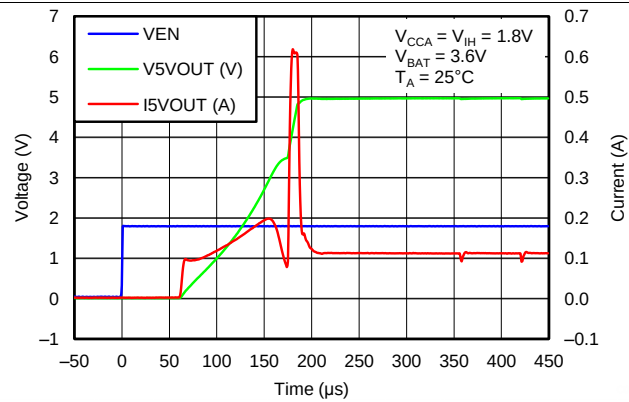


Figure 8. Voltage and Current vs Time

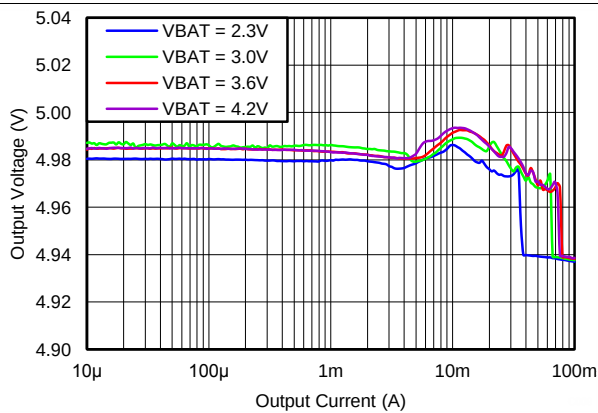


Figure 9. Output Voltage vs Output Current

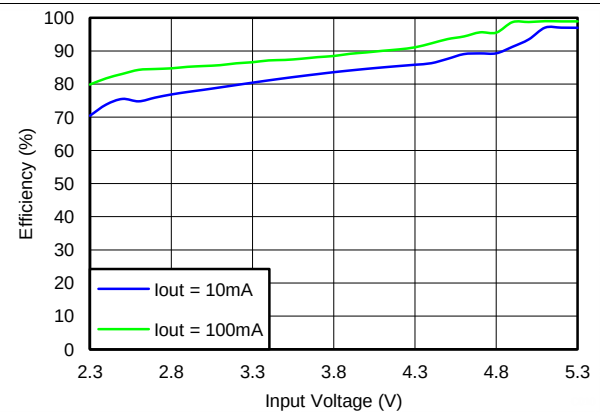


Figure 10. Efficiency vs Input Voltage

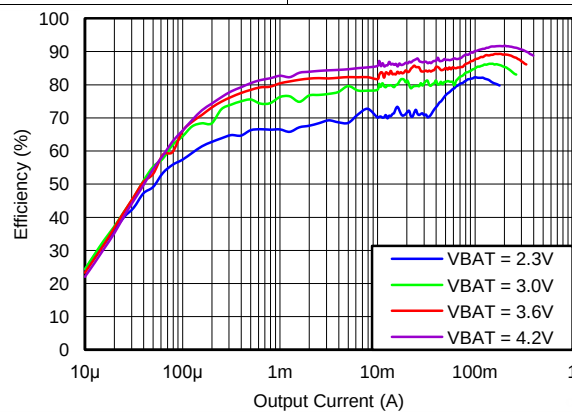


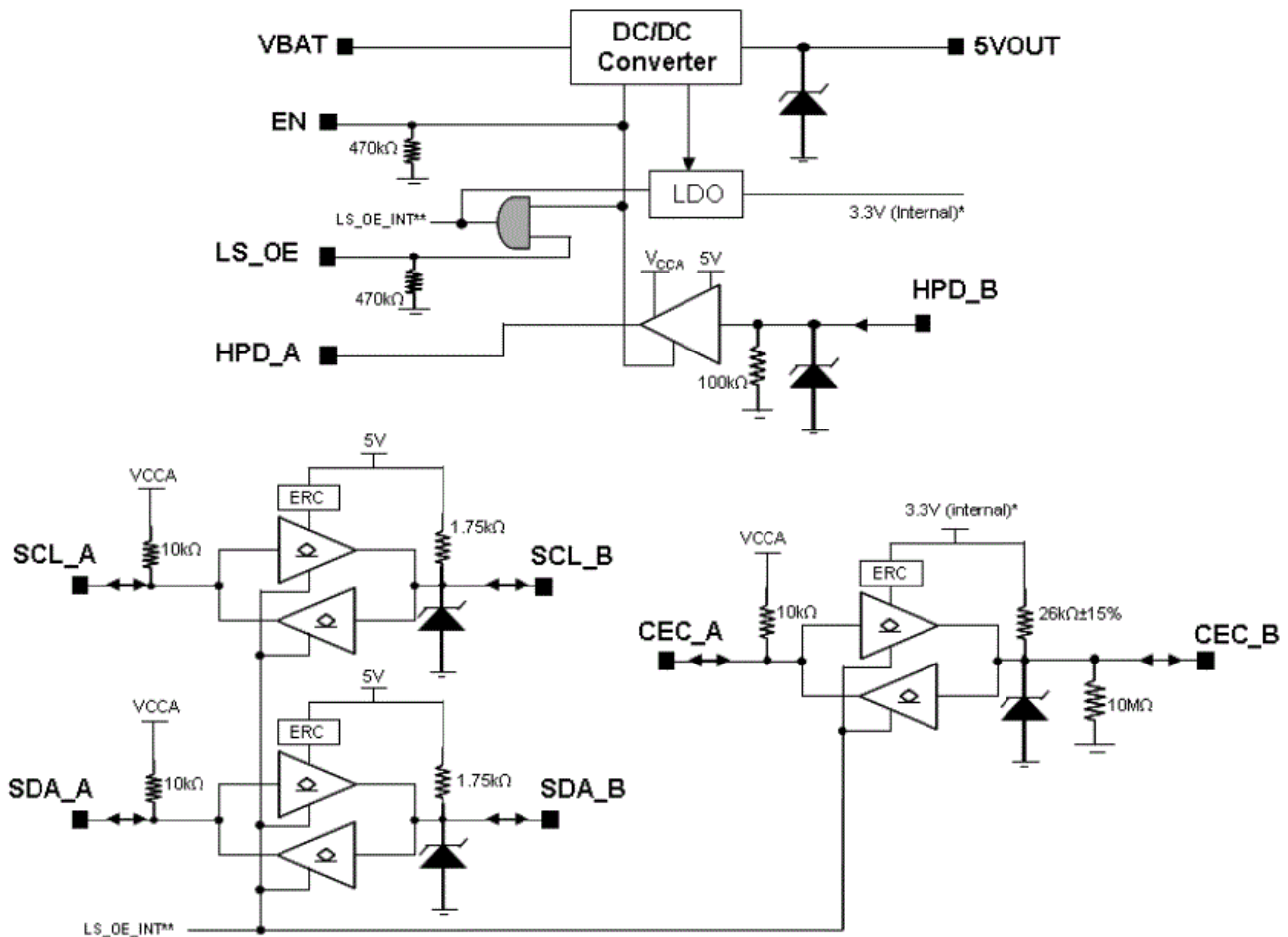
Figure 11. Efficiency vs Output Current

## 7 Detailed Description

### 7.1 Overview

The TPD5S115 is an integrated interface solution that covers HDMI versions' 2.0, 1.4, and 1.3 need for power supply voltage management and control line level translation. On the power supply line, it has a DC-DC converter that takes the internal power supply from 2.3 V to 5.5 V, and outputs a regulated and current-limited, 5-V voltage to the connector. The drivers support level translation on HPD, ECE, SCL, and SDA lines in both transmission directions. Moreover, the rise-time acceleration feature helps drive the high capacitive load on the cable side. Every channel comes with robust ESD protection with  $\pm 14$ -kV contact and  $\pm 16$ -kV air-gap IEC61000-4-2 capability.

### 7.2 Functional Block Diagram



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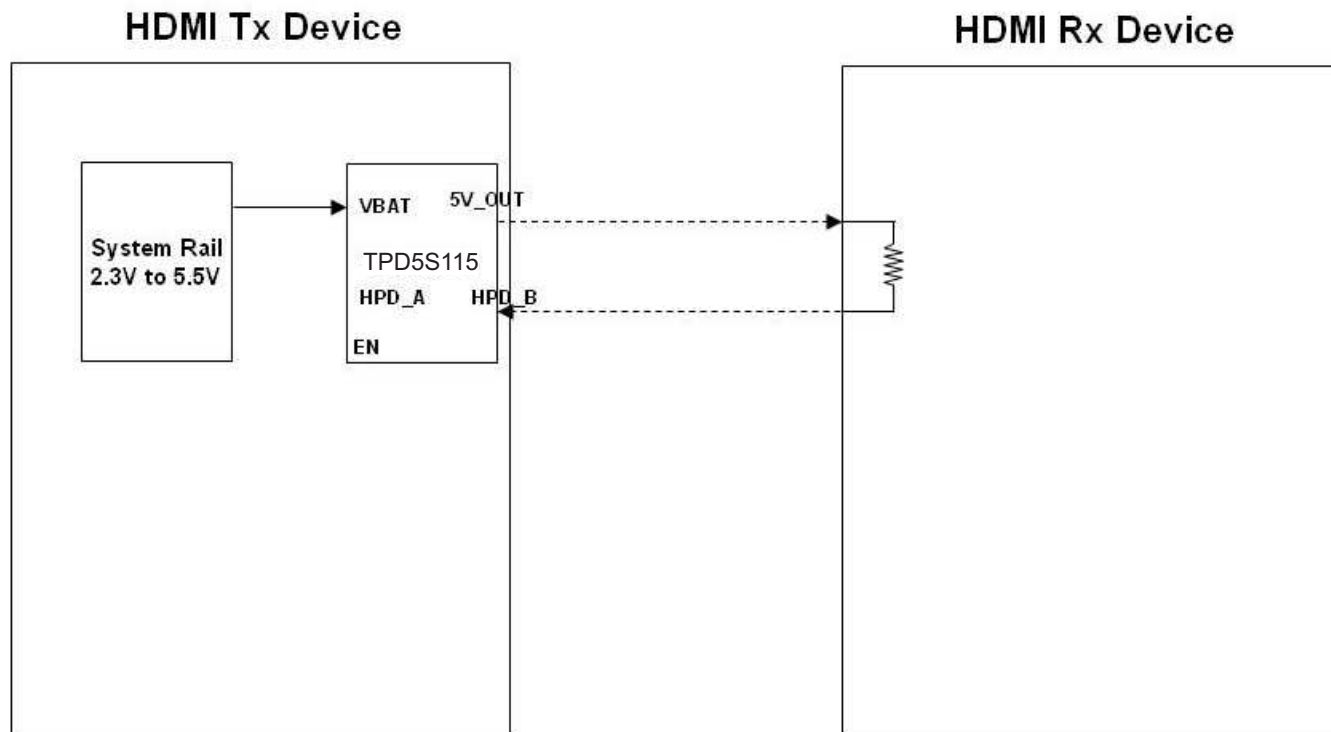
- (1) 3.3 V (internal) is an internal 3.3-V supply rail which is generated from 5VOUT when EN and LS\_OE are HIGH.
- (2) LS\_OE\_INT is an internal control signal generated from EN and LS\_OE signals. LS\_OE\_INT is active when both EN and LS\_OE are HIGH.

### 7.3 Feature Description

#### 7.3.1 Rise-Time Accelerators

The HDMI cable side of the DDC lines incorporates rise-time accelerators to support the high capacitive load on the HDMI cable side. The rise-time accelerator boosts the cable-side DDC signal, independent of which side of the bus is releasing the signal.

## Feature Description (continued)



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**Figure 12. Receiving and Transmitting Interaction**

### 7.3.2 Hot Plug Detect

After the TPD5S115's DC-DC converter and HPD block are enabled through the EN pin, the TPD5S115 is ready for continual HDMI receiver detection. After a HDMI cable connects a receiving and transmitting device together, the 5-V signal from the DC-DC output flows through the receiving device's internal resistor and into HPD's input. The HPD buffer's output then goes high, indicating to the transmitter that a receiving device is connected. To save power, periodic detection can be done by turning on and off the DC-DC converter before a receiving device is connected.

#### NOTE

Ground offset between the TPD5S115 ground and the ground of devices on port A of the TPD5S115 must be avoided. A CMOS or NMOS open-drain capable of sinking 3 mA of current at 0.4 V has an output resistance of 133  $\Omega$  or less ( $R = E / I$ ). Such a driver shares enough current with the port A output pulldown of the TPD5S115 to be detected as a LOW while the ground offset is zero. If the ground offset is greater than 0 V, then the driver resistance must be less. Because  $V_{ILC}$  can be as low as 90 mV at cold temperatures and the low end of the current distribution, the maximum ground offset should not exceed 50 mV. Bus repeaters that use an output offset are not interoperable with the port A of the TPD5S115 as their output LOW levels are not recognized by the TPD5S115 as a LOW. If the TPD5S115 is placed in an application where the  $V_{IL}$  of port A of the TPD5S115 does not go below its  $V_{ILC}$  it will pull port B LOW initially when port A input transitions LOW but the port B will return HIGH, so it does not reproduce the port A input on port B. Such applications must be avoided. Port B is interoperable with all I<sup>2</sup>C-bus slaves, masters, and repeaters.

## **Feature Description (continued)**

### **7.3.3 CEC Level Shift Operation**

The CEC level shift function operates in the same manner as the DDC lines except that the CEC line does not need the rise time accelerator function.

### **7.3.4 Pullup Resistor**

The system is designed to work properly with no external pullup resistors on the DDC, CEC, and HPD lines.

### **7.3.5 Undervoltage Lockout**

The undervoltage-lockout circuit prevents the DC-DC converter from malfunctioning at low input voltages and from excessive discharge of the battery. It disables the output stage of the converter once the falling  $V_{IN}$  trips the undervoltage-lockout threshold ( $V_{BATUV}$ ). The undervoltage-lockout threshold for falling  $V_{IN}$  is typically 2 V. The device starts operation once the rising  $V_{IN}$  trips the under-voltage-lockout threshold again at 2.1 V (typical).

### **7.3.6 Soft Start**

The DC-DC converter has an internal soft-start circuit that controls the ramp-up of the output voltage. The output voltage reaches its nominal value within 250  $\mu$ s (typical) after EN has been pulled high. The output voltage ramps up from 5% to its nominal value within 300  $\mu$ s (typical). This limits the in-rush current in the converter during start-up and prevents possible input voltage drops when a battery or high impedance power source is used. During soft start, the switch current limit is reduced to 300 mA until the output voltage reaches  $V_{IN}$ . Once the output voltage trips this threshold, the device operates with its nominal current limit.

## **7.4 Device Functional Modes**

### **7.4.1 Power-Save Mode**

The TPD5S115 integrates a power-save mode to improve efficiency at light loads. In power-save mode, the converter only operates when the output voltage trips below a set threshold voltage. It ramps up the output voltage with several pulses and goes into power-save mode once the output voltage exceeds the set threshold voltage. The PFM mode is ended and PWM mode begins in case the output current can no longer be supported in PFM mode.

### **7.4.2 Enable**

The DC-DC converter is enabled when the EN is set to high. At first, the internal reference is activated and the internal analog circuits are settled. Afterwards, the soft start is activated and the output voltage is ramped up. The output voltage reaches its nominal value in 250  $\mu$ s (typical) after the device has been enabled. The EN input can be used to control power sequencing in a system with various DC-DC converters. The EN pin can be connected to the output of another converter to drive the EN pin high and create a sequencing of supply rails. When EN = GND, the converter enters shutdown mode.





## Typical Applications (continued)

### 8.2.1.1 Design Requirements

For this design example, use the parameters listed in [Table 1](#) as the input parameters.

**Table 1. Design Parameters**

| PARAMETER                                | VALUE            |
|------------------------------------------|------------------|
| 5VOUT DC current                         | 55 mA            |
| CEC_A, HPD_A, SCL_A, SDA_A voltage level | V <sub>CCA</sub> |
| HDMI 2.0 data rate per TMDS signal pair  | 6 Gbps           |
| Required IEC 61000-4-2 ESD Protection    | ±8-kV contact    |

### 8.2.1.2 Detailed Design Procedure

#### 8.2.1.2.1 DDC or CEC Level Shifter Operational Notes for V<sub>CCA</sub> = 1.8 V

- The threshold of CMP1 is approximately 150 mV ± the 40 mV of total hysteresis
- The comparator trips for a falling waveform at approximately 130 mV
- The comparator trips for a rising waveform at approximately 170 mV
- To be recognized as a zero, the level at port A must first go below 130 mV (V<sub>ILC</sub> in spec) and then stay below 170 mV (V<sub>ILA</sub> in spec)
- To be recognized as a one, the level at A must first go above 170 mV and then stay above 130 mV
- V<sub>ILC</sub> is specified as 110 mV in [Electrical Characteristics](#) to give some margin to the 130 mV
- V<sub>ILA</sub> is specified as 140 mV in [Electrical Characteristics](#) to give some margin to the 170 mV
- V<sub>IHA</sub> is specified as 70% of V<sub>CCA</sub> to be consistent with standard CMOS levels

#### 8.2.1.2.2 Input Capacitor

Due to the nature of the boost converter having a pulsating input current, a low-ESR input capacitor is required to prevent large voltage transients that can cause poor performance of the device or interference with other circuits in the system. TI recommends a 1.2-μF (minimum) input capacitor to improve transient behavior of the regulator and EMI behavior of the total power-supply circuit. TI recommends placing a ceramic capacitor (4.7 μF) as close as possible to the V<sub>IN</sub> and GND pins to improve the input noise filtering.

#### 8.2.1.2.3 Output Capacitor

TI recommends using a small ceramic capacitors placed as close as possible to the V<sub>OUT</sub> and GND pins of the IC. If the application requires the use of large capacitors which can not be placed close to the IC, TI recommends using a smaller ceramic capacitor in parallel to the large capacitor. This small capacitor must be placed as close as possible to the V<sub>OUT</sub> and GND pins of the IC. Use [Equation 1](#) to estimate the recommended minimum output capacitance.

$$C_{\min} = \frac{I_{\text{OUT}} \times (V_{\text{OUT}} - V_{\text{IN}})}{f \times \Delta V \times V_{\text{OUT}}}$$

where

- f is the switching frequency
- ΔV is the maximum allowed ripple

(1)

If a ripple voltage of 10 mV is chosen, a minimum effective capacitance of 2.7 μF is needed. The total ripple is larger due to the ESR of the output capacitor. This additional component of the ripple can be calculated using [Equation 2](#).

$$\Delta V_{\text{ESR}} = I_{\text{OUT}} \times R_{\text{ESR}}$$

(2)

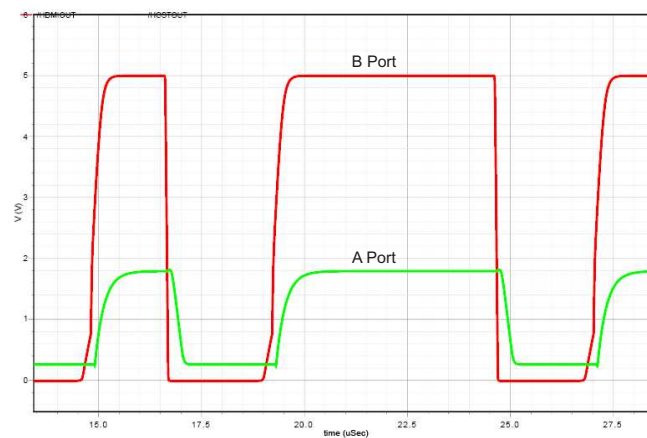
To maintain control loop stability, a capacitor with a value in the range of the calculated minimum must be used. There are no additional requirements regarding minimum ESR. There is no upper limit for the output capacitance value. Larger capacitors cause lower output voltage ripple as well as lower output voltage drop during load transients.

Ceramic capacitors have a DC-bias effect, which has a strong influence on the final effective capacitance needed. Therefore the appropriate capacitor value must be chosen very carefully. Package size, voltage rating, and material are responsible for differences between the rated capacitor value and the effective capacitance. The minimum effective capacitance value is 1.2  $\mu\text{F}$ , but the recommended value is 4.7  $\mu\text{F}$ .

**Table 2. Passive Components: Recommended Effective Values**

| COMPONENT  | MIN | TYP | MAX | UNIT          |
|------------|-----|-----|-----|---------------|
| $C_{IN}$   | 1.2 | 4.7 | 6.5 | $\mu\text{F}$ |
| $C_{OUT}$  | 1.2 | 4.7 | 10  | $\mu\text{F}$ |
| $L_{IN}$   | 0.7 | 1   | 1.3 | $\mu\text{H}$ |
| $C_{VCCA}$ |     | 0.1 |     | $\mu\text{F}$ |

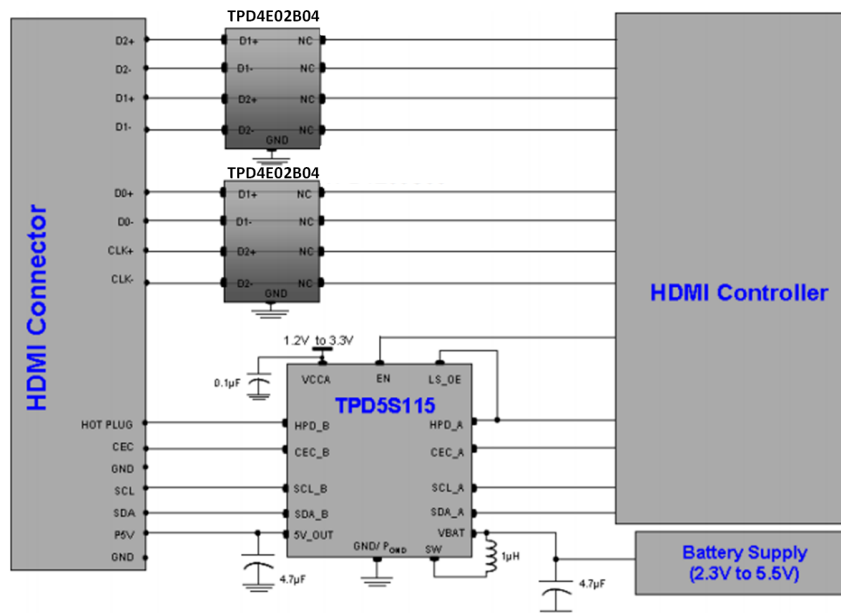
### 8.2.1.3 Application Curve



**Figure 14. DDC Level Shifter Operation (B to A Direction)**

## 8.2.2 Other Application Circuits

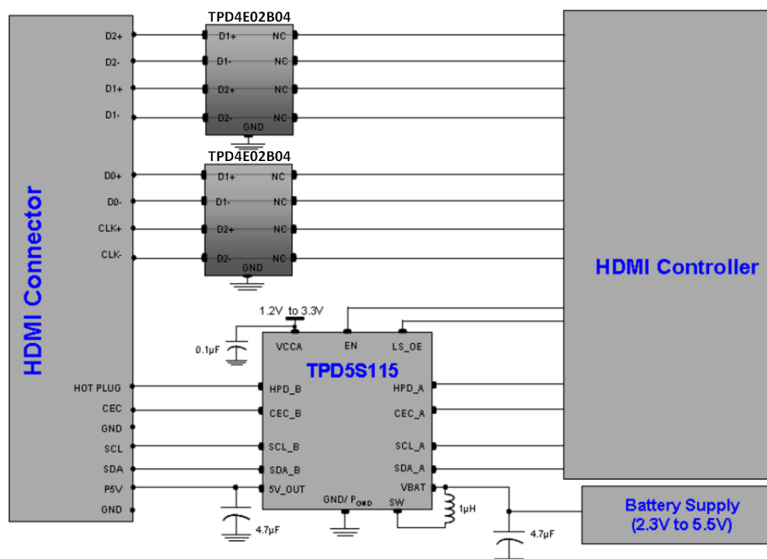
Figure 15 and Figure 16 show application examples using the TPD5S115 devices. Customers must fully validate and test any circuit before implementing a design based on an example in this section. Unless otherwise noted, the design procedures in [DDC or CEC Level Shifter](#) are applicable.



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Figure 15. Application Schematic for HDMI Controllers With One GPIO for HDMI Interface Control

Some HDMI controllers may have only one GPIO to control the HDMI interface, thus, the HDMI driver chip controls the TPD5S115 through only one control line (EN). In this mode the HPD\_A to LS\_OE pins are connected to each other (see Figure 15).



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Figure 16. Application Schematic for HDMI Controllers With Two GPIOs for HDMI Interface Control

## TPD5S115

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Some HDMI driver chips may have two GPIOs to control the HDMI interface chip. In this case a flexible power saving mode can be implemented. The LS\_OE and EN are active-high enable pins. They control the TPD5S115 power-saving options according to [Table 3](#) and [Table 4](#).

**Table 3. Device Status – Part 1**

| LS_OE | EN | V <sub>CCA</sub> | V <sub>BAT</sub> | 5VOUT  | A-SIDE PULLUPS | DCC, B-SIDE PULLUPS | CEC, B-SIDE PULLUPS |
|-------|----|------------------|------------------|--------|----------------|---------------------|---------------------|
| L     | L  | 1.8 V            | 5 V              | Off    | Off            | Off                 | Off                 |
| L     | H  | 1.8 V            | 5 V              | On     | On             | On                  | Off                 |
| H     | L  | 1.8 V            | 5 V              | Off    | Off            | Off                 | Off                 |
| H     | H  | 1.8 V            | 5 V              | On     | On             | On                  | On                  |
| X     | X  | 0 V              | 0 V              | High-Z | High-Z         | High-Z              | High-Z              |
| X     | X  | 1.8 V            | 0 V              | Low    | Low            | High-Z              | High-Z              |
| X     | X  | 0 V              | 5 V              | High-Z | High-Z         | High-Z              | High-Z              |

**Table 4. Device Status – Part 2**

| LS_OE | EN | CEC LDO | DC-DC AND HPD | DDC OR CEC VLTS | I <sub>CCA</sub> TYP | I <sub>CC</sub> V <sub>BAT</sub> TYP | COMMENT               |
|-------|----|---------|---------------|-----------------|----------------------|--------------------------------------|-----------------------|
| L     | L  | Off     | Off           | OFF and High-Z  | 1 $\mu$ A            | 1 $\mu$ A                            | Fully disabled        |
| L     | H  | Off     | On            | OFF and High-Z  | 1 $\mu$ A            | 30 $\mu$ A                           | DC-DC (30 $\mu$ A) ON |
| H     | L  | Off     | Off           | OFF and High-Z  | 1 $\mu$ A            | 1 $\mu$ A                            | Not valid state       |
| H     | H  | On      | On            | ON              | 13 $\mu$ A           | 225 $\mu$ A                          | Fully ON              |
| X     | X  | Off     | Off           | High-Z          | 0 $\mu$ A            | 0 $\mu$ A                            | Power down            |
| X     | X  | Off     | Off           | High-Z          | 0 $\mu$ A            | 0 $\mu$ A                            | Power down            |
| X     | X  | Off     | Off           | High-Z          | 0 $\mu$ A            | 0 $\mu$ A                            | Power down            |

## 9 Power Supply Recommendations

To keep the normal function of TPD5S115, the designer needs to make sure that both VBAT and VCCA are within the recommended operating range. See [Detailed Design Procedure](#) for power supply recommendations.

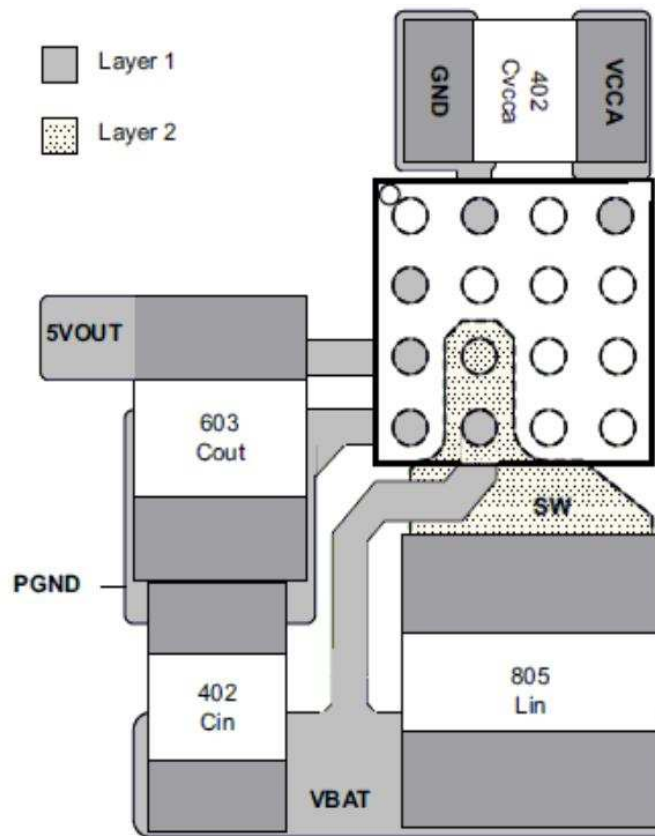
## 10 Layout

### 10.1 Layout Guidelines

For proper operation, follow these layout and design guidelines:

- Place the TPD5S115 as close to the connector as possible. This allows it to remove the energy associated with ESD strike before it reaches the internal circuitry of the system board.
- Place power line capacitors and inductors close to the pins with wide traces to allow enough current to flow through with less trace parasitics. Ensure that there is enough metallization for the GND pad. A sufficient current path enables safe discharge of all the energy associated with the ESD strike.

### 10.2 Layout Example



**Figure 17. Board Layout With DC-DC Components (Top View)**

## 11 器件和文档支持

### 11.1 文档支持

#### 11.1.1 相关文档

请参阅如下相关文档：

- [阅读并了解 ESD 保护数据表](#)
- [《ESD 布局指南》](#)

### 11.2 接收文档更新通知

要接收文档更新通知，请导航至德州仪器 [Ti.com.cn](http://Ti.com.cn) 上的器件产品文件夹。请单击右上角的通知我 进行注册，即可收到任意产品信息更改每周摘要。有关更改的详细信息，请查看任意已修订文档中包含的修订历史记录。

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### 11.6 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 12 机械、封装和可订购信息

以下页面包括机械、封装和可订购信息。这些信息是指定器件的最新可用数据。这些数据发生变化时，我们可能不会另行通知或修订此文档。如欲获取此产品说明书的浏览器版本，请参阅左侧的导航栏。

## PACKAGING INFORMATION

| Orderable part number        | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">TPD5S115YFFR</a> | Active        | Production           | DSBGA (YFF)   16 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | RE115               |
| TPD5S115YFFR.A               | Active        | Production           | DSBGA (YFF)   16 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | RE115               |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

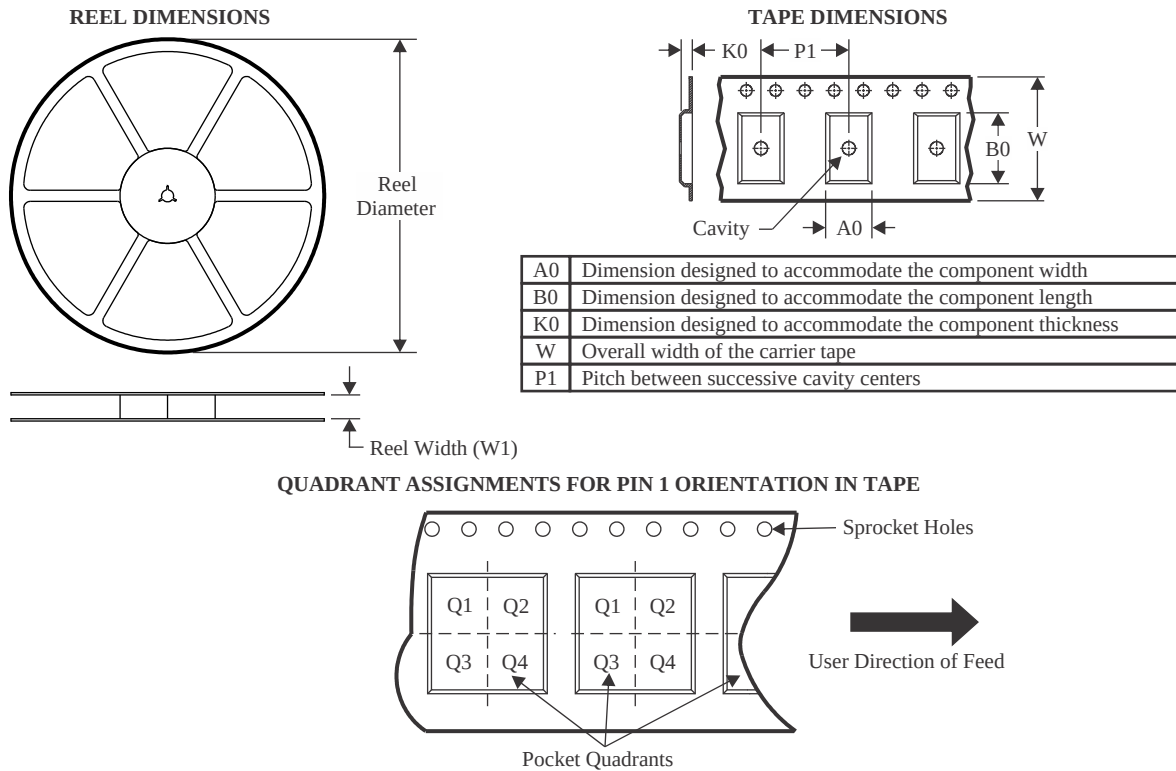
<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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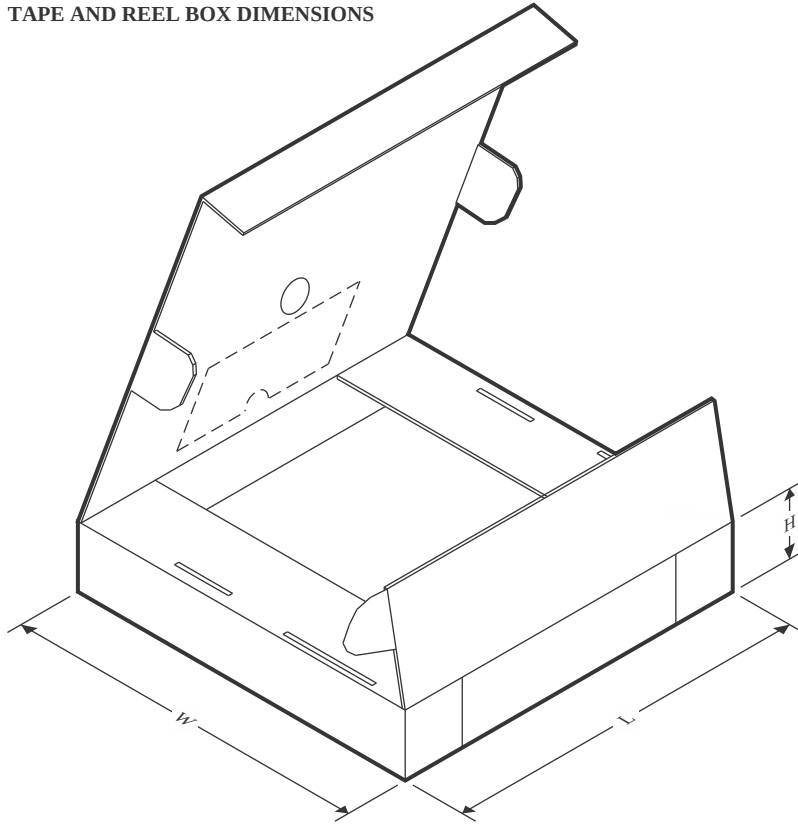


\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TPD5S115YFFR | DSBGA        | YFF             | 16   | 3000 | 180.0              | 8.4                | 1.84    | 1.84    | 0.69    | 4.0     | 8.0    | Q1            |



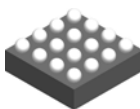
## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPD5S115YFFR | DSBGA        | YFF             | 16   | 3000 | 182.0       | 182.0      | 20.0        |

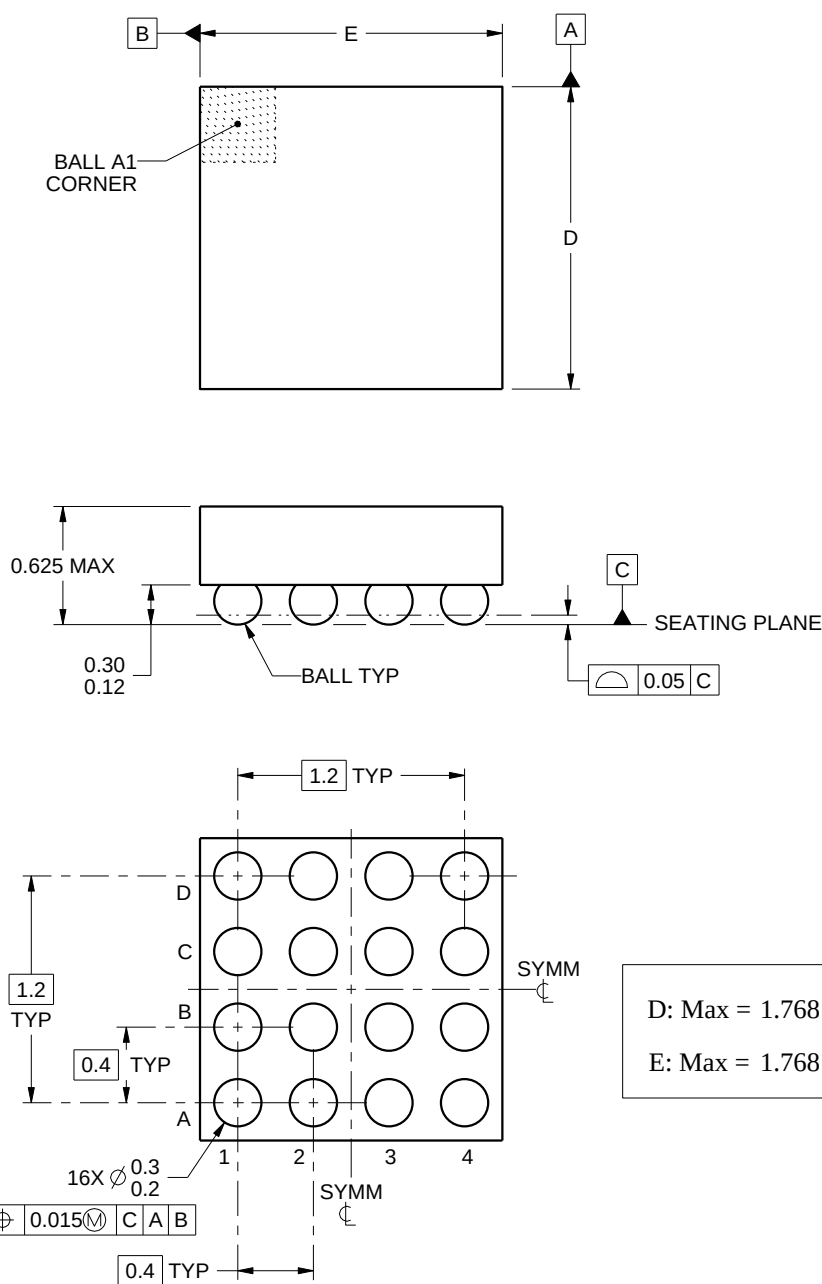
YFF0016



# PACKAGE OUTLINE

DSBGA - 0.625 mm max height

DIE SIZE BALL GRID ARRAY



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## NOTES:

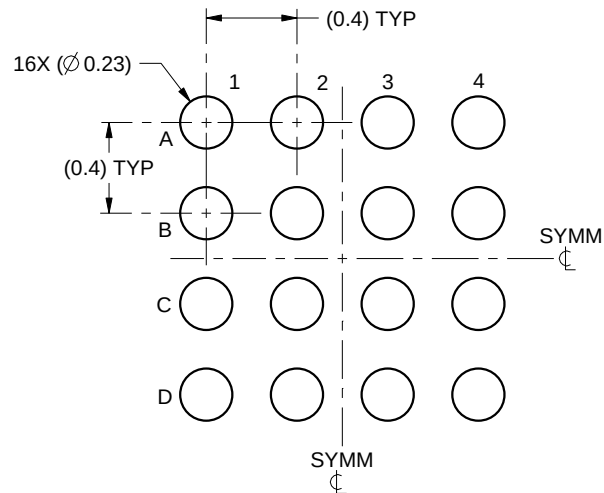
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

# EXAMPLE BOARD LAYOUT

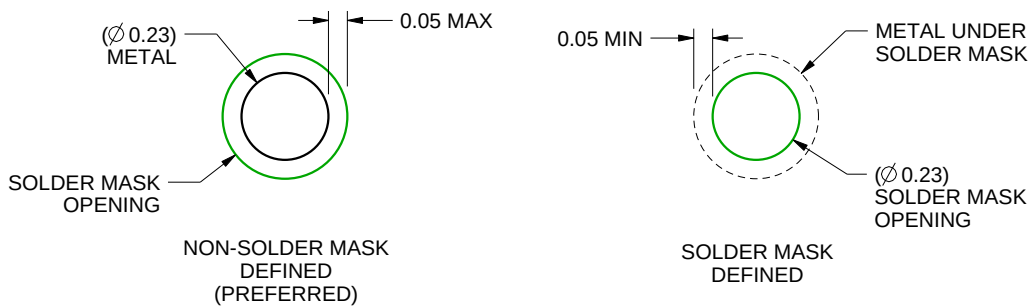
YFF0016

DSBGA - 0.625 mm max height

DIE SIZE BALL GRID ARRAY



LAND PATTERN EXAMPLE  
SCALE:30X



SOLDER MASK DETAILS  
NOT TO SCALE

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NOTES: (continued)

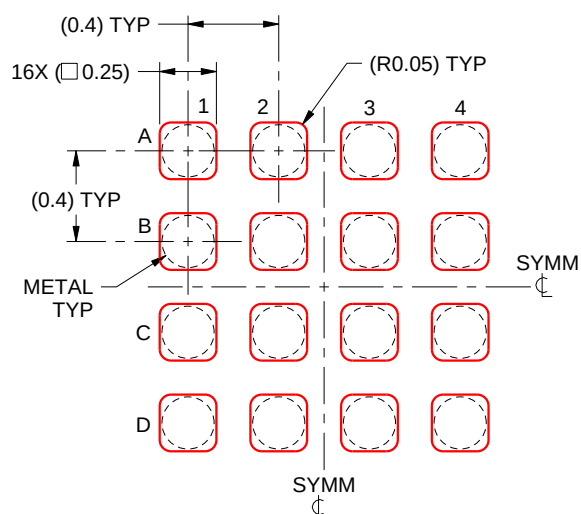
3. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For more information, see Texas Instruments literature number SNVA009 ([www.ti.com/lit/snva009](http://www.ti.com/lit/snva009)).

## EXAMPLE STENCIL DESIGN

YFF0016

DSBGA - 0.625 mm max height

DIE SIZE BALL GRID ARRAY



SOLDER PASTE EXAMPLE  
BASED ON 0.1 mm THICK STENCIL  
SCALE:30X

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NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.

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